



SSC8P20AN3

N-Channel Enhancement Mode MOSFET with PNP Transistor

➤ Features

N-Channel:

V_{DS}	V_{GS}	$R_{DS(on)}$ Typ.	I_D
20V	±8V	200mΩ@4V5	0.8A
		250mΩ@2V5	

PNP Transistor:

V_{CB}	V_{CE}	V_{EB}	V_{CESAT} Typ.	I_C
-40V	-40V	-6V	-180mV	-1A

➤ Description

The SSC8P20AN3 combines an N-Channel enhancement mode power MOSFET which is produced with high cell density and a Media Power PNP Transistor. The tiny and thin outline saves PCB consumption.

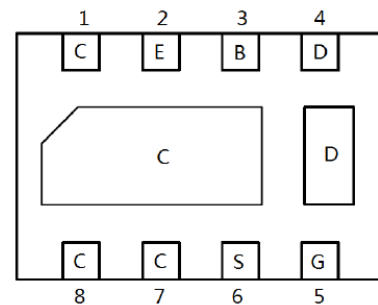
➤ Applications

- Power management
- Charging circuits
- Li-Battery Charging
- Power switches

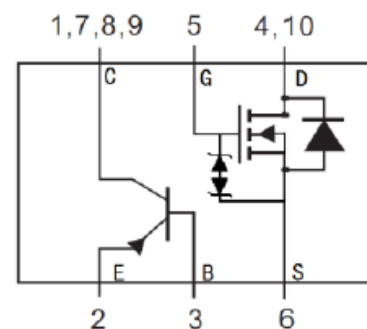
➤ Ordering Information

Device	Package	Shipping
SSC8P20AN3	DFN3x2-8L	3000/Reel

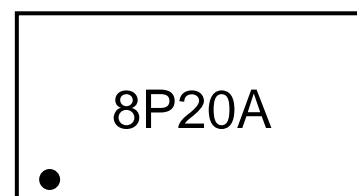
➤ Pin configuration



DFN3X2-8L (Bottom View)



Circuit Diagram



Marking (Top View)



➤ **Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
N-MOS			
V_{DSS}	Drain-to-Source Voltage	20	V
V_{GSS}	Gate-to-Source Voltage	± 8	V
I_D	Continuous Drain Current	0.8	A
I_{DM}	Pulsed Drain Current	3	A
PNP Transistor			
V_{CBO}	Collector-Base Voltage	-40	V
V_{CEO}	Collector-Emitter Voltage	-40	V
V_{EBO}	Emitter-Base Voltage	-6	V
I_C	Collector Current	-1	A
I_{CM}	Pulsed Collector Current	-2	A
Power Dissipation and Temperature			
P_D	Power Dissipation ^a	2.1	W
T_A	Operation Temperature Range	-40 to 85	$^\circ\text{C}$
T_L	Lead Temperature	260	$^\circ\text{C}$
T_J	Operation Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature	-55 to 150	$^\circ\text{C}$

➤ **Thermal Resistance Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)**

Parameter	Symbol	Value	Unit
Junction-to-Ambient Thermal Resistance ^a	$R_{\theta JA}$	45	$^\circ\text{C}/\text{W}$

Note:

- a. The value of $R_{\theta JA}$ is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The Power dissipation P_D is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.

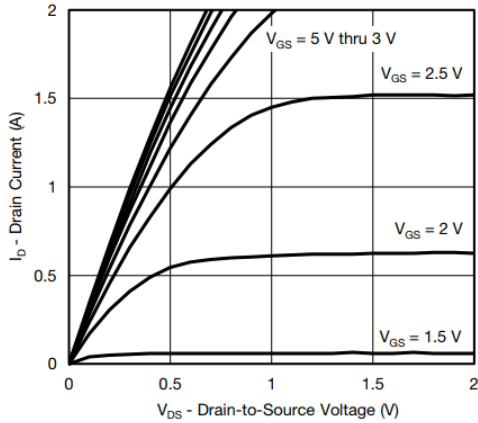


➤ **Electrical Characteristics (T_A=25°C unless otherwise noted)**

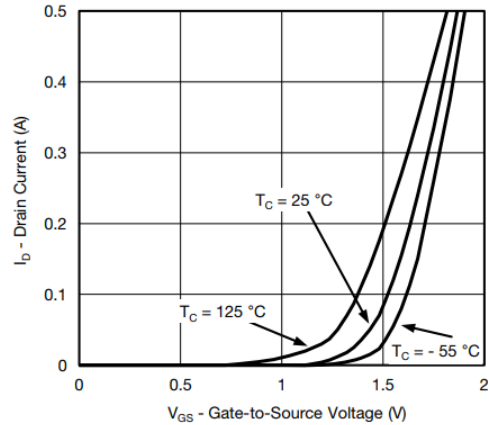
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
N-Channel Enhancement Mode MOSFET						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250uA	20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	0.35	0.6	1	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 0.5A		200	600	mΩ
		V _{GS} = 2.5V, I _D = 0.5A		250	850	
		V _{GS} = 1.8V, I _D = 0.35A		350	950	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16V, V _{GS} = 0V			1	μA
Gate-Source leak current	I _{GSS}	V _{GS} = ±8V, V _{DS} = 0V			±10	μA
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 1A			1.3	V
Transconductance	G _{FS}	V _{DS} = 5V, I _D = 0.5A		2.2		s
Input Capacitance	C _{ISS}	V _{DS} = 16V, V _{GS} = 0V, f = 200kHz		130		pF
Output Capacitance	C _{OSS}			20		
Reverse Transfer Capacitance	C _{RSS}			16		
Turn-on Delay Time	T _{D(ON)}	V _{DS} = 6V, V _{GS} = 4.5V, R _L = 6Ω, R _G = 6Ω, I _D = 0.8A		6		ns
Turn-on Rise Time	Tr			23		
Turn-off Delay Time	T _{D(OFF)}			42		
Turn-off Fall Time	Tf			78		
PNP Transistor						
Collector-Base Breakdown Voltage	BV _{CB0}	I _C = -50μA, I _E = 0	-40			V
Collector-emitter Breakdown Voltage	BV _{CEO}	I _C = -1mA, I _B = 0	-40			V
Emitter -Base Breakdown Voltage	BV _{EBO}	I _E = --50μA, I _C = 0	-6			V
Collector Cutoff Current	I _{CB0}	V _{CB} = -20V, I _E = 0			-0.1	μA
Emitter Cutoff Current	I _{EBO}	V _{EB} = -4V, I _C = 0			-0.1	μA
DC Current Gain	h _{FE}	V _{CE} = -2V, I _C = -0.5A	100		360	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _C = -0.8A, I _B = -80mA		-0.18	-0.5	V
Base-Emitter Saturation Voltage	V _{BE(sat)}	I _C = -0.8A, I _B = -80mA			-1.2	V
Transition frequency	f _T	V _{CE} = -6V, I _C = -20mA, f=30MHz	150			MHz



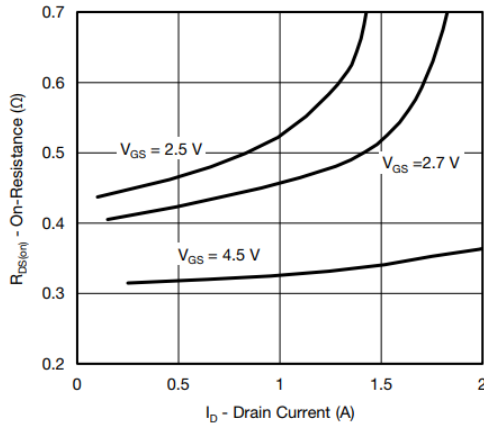
➤ N-Channel Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)



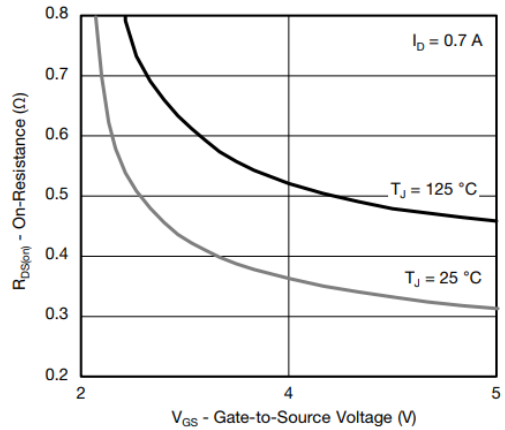
Output Characteristics



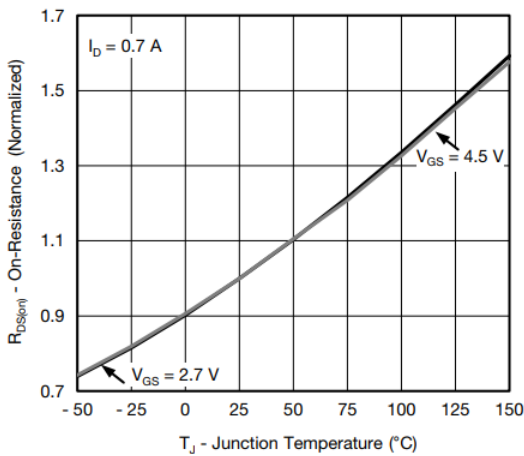
Transfer Characteristics



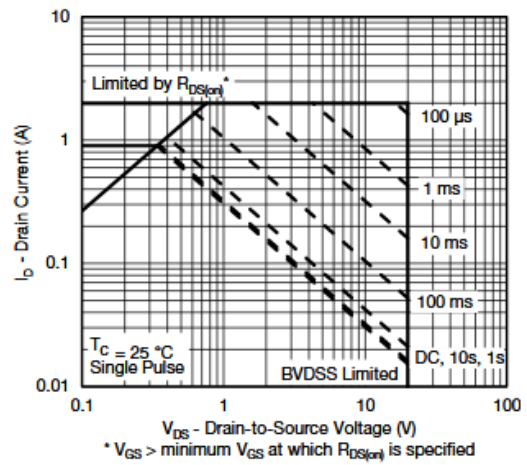
On-Resistance vs. Drain Current and Gate Voltage



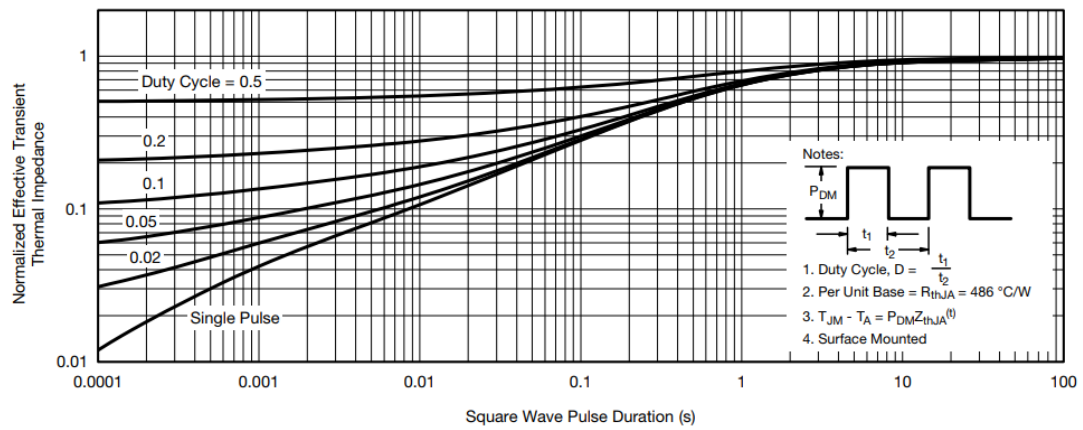
On-Resistance vs. Gate-to-Source Voltage



On-Resistance vs. Junction Temperature



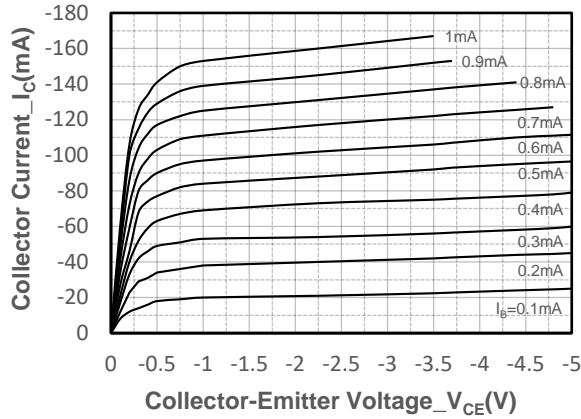
Safe Operating Area, Junction-to-Ambient



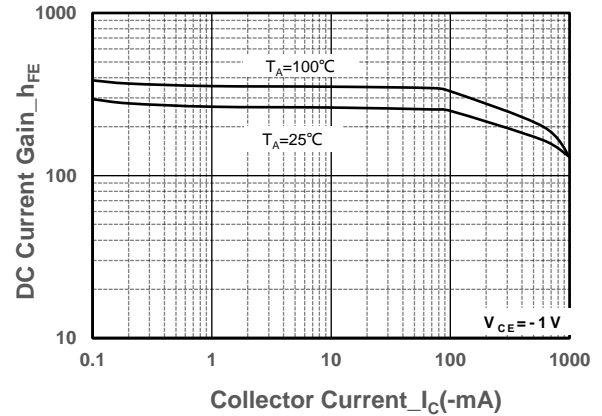
Normalized Thermal Transient Impedance, Junction-to-Ambient



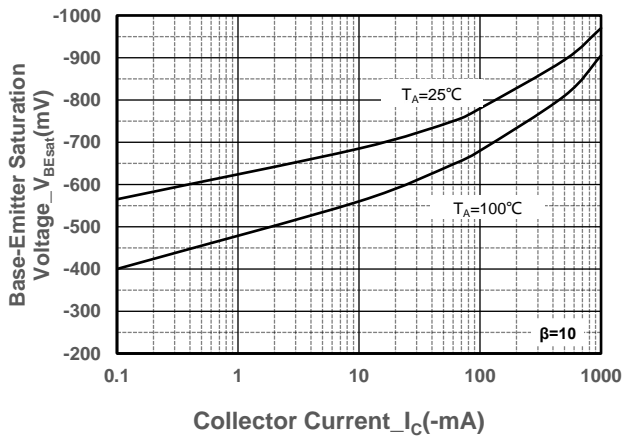
PNP Transistor Typical Performance Characteristics ($T_A=25^\circ\text{C}$)



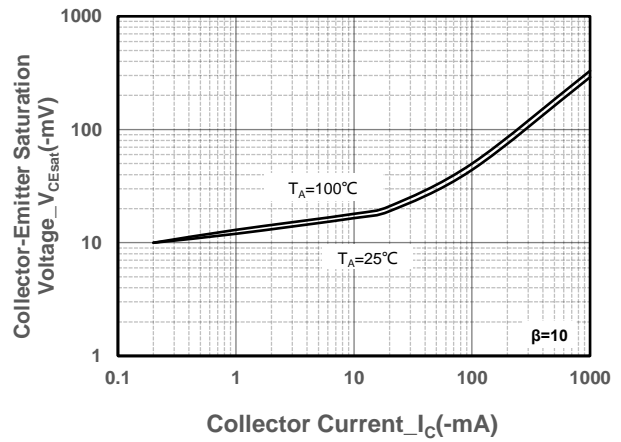
Collector Current vs. Collector-Emitter Voltage



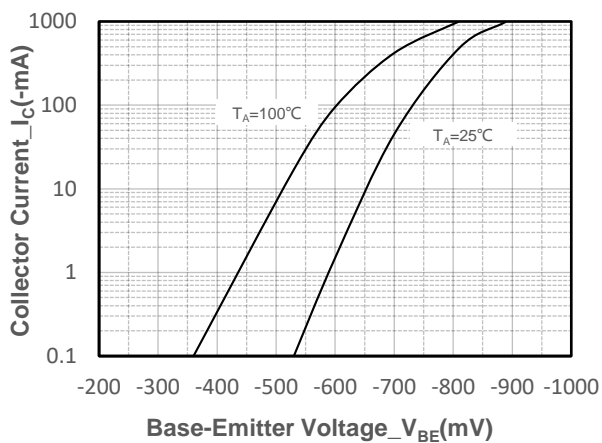
DC Current Gain vs. Collector Current



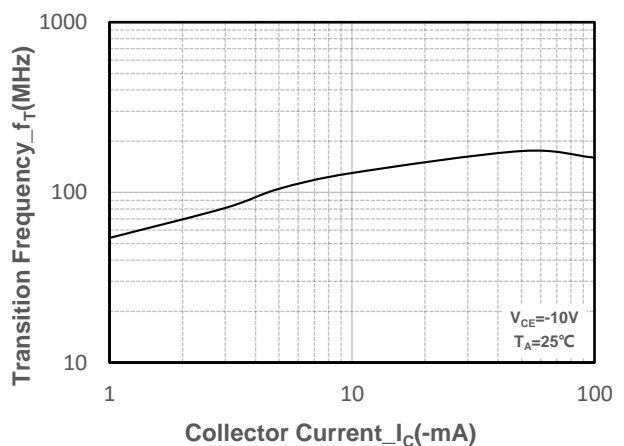
$V_{BE(sat)}$ vs. Collector Current



$V_{CE(sat)}$ vs. Collector Current

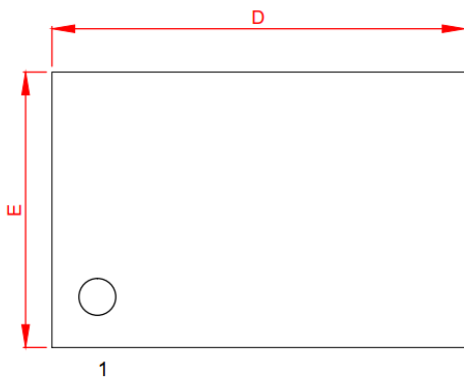


Collector Current vs. Base-Emitter Voltage

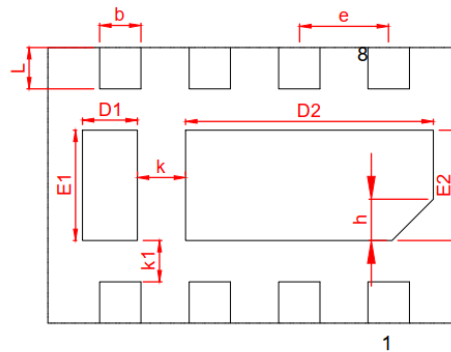


Transition Frequency vs. Collector Current

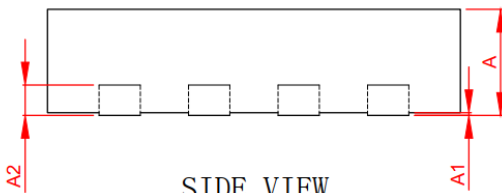
➤ Package Information



TOP VIEW



BOTTOM VIEW



SIDE VIEW

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
* A1	0.00	0.02	0.05
* b	0.25	0.30	0.35
A2	0.203 BSC		
* D	2.90	3.00	3.10
* E	1.90	2.00	2.10
* E1	0.75	0.80	0.85
* E2	0.75	0.80	0.85
* D1	0.35	0.40	0.45
* D2	1.75	1.80	1.85
* e	0.65 REF		
* L	0.25	0.30	0.35
h	BSC 0.42		
* k1	0.30	0.35	0.40
* k2	0.25	0.30	0.35

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